

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Dong-Kil SHIN et al.

Serial No.: 10/772,651 Examiner: Warren, Matthew E.

Filed: February 4, 2004 Group Art Unit: 2815

Confirmation No.: 5815

For: MULTI-CHIP PACKAGE WITH SOFT ELEMENT AND METHOD OF
MANUFACTURING THE SAME

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Responsive to the Office Action, Paper No. 20071226, dated December 31, 2007, please amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.